

## TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

ETAS ID: TM756444

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT		
<b>NATURE OF CONVEYANCE:</b>	CHANGE OF NAME		
<b>CONVEYING PARTY DATA</b>			
<b>Name</b>	<b>Formerly</b>	<b>Execution Date</b>	<b>Entity Type</b>
Invensas Bonding Technologies, Inc.		08/15/2022	Corporation:
<b>RECEIVING PARTY DATA</b>			
<b>Name:</b>	Adeia Semiconductor Bonding Technologies, Inc.		
<b>Street Address:</b>	3025 Orchard Parkway		
<b>City:</b>	San Jose		
<b>State/Country:</b>	CALIFORNIA		
<b>Postal Code:</b>	95134		
<b>Entity Type:</b>	Corporation: DELAWARE		
<b>PROPERTY NUMBERS Total: 1</b>			
<b>Property Type</b>	<b>Number</b>	<b>Word Mark</b>	
<b>Registration Number:</b>	4114294	ZIBOND	
<b>CORRESPONDENCE DATA</b>			
<b>Fax Number:</b>			
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
<b>Phone:</b>	16469732505		
<b>Email:</b>	rebecca.rothkopf@hglaw.com		
<b>Correspondent Name:</b>	rebecca rothkopf		
<b>Address Line 1:</b>	75 broad st		
<b>Address Line 4:</b>	new york, NEW YORK 10004		
<b>NAME OF SUBMITTER:</b>	Rebecca Rothkopf		
<b>SIGNATURE:</b>	/Rebecca Rothkopf/		
<b>DATE SIGNED:</b>	09/20/2022		
<b>Total Attachments: 0</b>			

OP \$40.00 4114294

**THIS  
PAGE  
INTENTIONALLY  
LEFT  
BLANK**